

Applicant Information

Applicant Authority Type:: Inventor
Applicant One Given Name:: Ai-Sen
Family Name:: Liu
Country:: Taiwan, R.O.C.

Correspondence Information

Correspondence Customer Number::27683

Application Information

Title Line One:: METHOD FOR FORMING DIELECTRIC BARRIER
Title Line Two:: LAYER IN DAMASCENE STRUCTURE
Total Drawing Sheets:: 7
Formal Drawings?:: No
Application Type:: Utility
Docket Number:: 24061.142
Secrecy Order in Parent Appl?:: No

Representative Information

Registration Number:: 42,044

Assignee Information

Assignee Name:: Taiwan Semiconductor Manufacturing Company, Ltd.
Street of mailing address:: No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park
City:: Hsin-Chu
Country of mailing address:: Taiwan, R.O.C.
Postal or Zip Code:: 300-77